

# MJD2955 (PNP) MJD3055 (NPN)

## Complementary Power Transistors

### DPAK For Surface Mount Applications

Designed for general purpose amplifier and low speed switching applications.

#### Features

- Lead Formed for Surface Mount Applications in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves (“-1” Suffix)
- Electrically Similar to MJE2955 and MJE3055
- DC Current Gain Specified to 10 Amperes
- High Current Gain–Bandwidth Product –  $f_T = 2.0 \text{ MHz (Min) @ } I_C = 500 \text{ mAdc}$
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V  
Machine Model, C > 400 V
- Pb–Free Packages are Available

#### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector–Emitter Voltage	$V_{CEO}$	60	Vdc
Collector–Base Voltage	$V_{CB}$	70	Vdc
Emitter–Base Voltage	$V_{EB}$	5	Vdc
Collector Current	$I_C$	10	Adc
Base Current	$I_B$	6	Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_{D\dagger}$	20 0.16	W W/ $^\circ\text{C}$
Total Power Dissipation (Note1) @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.75 0.014	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction–to–Case	$R_{\theta JC}$	6.25	$^\circ\text{C/W}$
Thermal Resistance, Junction–to–Ambient (Note1)	$R_{\theta JA}$	71.4	$^\circ\text{C/W}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

†Safe Area Curves are indicated by Figure 1. Both limits are applicable and must be observed.

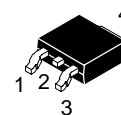
1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.



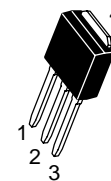
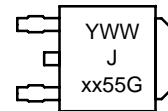
ON Semiconductor®

## SILICON POWER TRANSISTORS 10 AMPERES 60 VOLTS, 20 WATTS

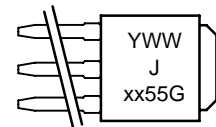
#### MARKING DIAGRAMS



DPAK  
CASE 369C  
STYLE 1



DPAK-3  
CASE 369D  
STYLE 1



Y = Year  
WW = Work Week  
Jxx55 = Device Code  
x = 29 or 30  
G = Pb–Free Package

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## MJD2955 (PNP) MJD3055 (NPN)

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector–Emitter Sustaining Voltage (Note 2) (I <sub>C</sub> = 30 mA <sub>dc</sub> , I <sub>B</sub> = 0)	V <sub>CEO(sus)</sub>	60	–	V <sub>dc</sub>
Collector Cutoff Current (V <sub>CE</sub> = 30 V <sub>dc</sub> , I <sub>B</sub> = 0)	I <sub>CEO</sub>	–	50	μA <sub>dc</sub>
Collector Cutoff Current (V <sub>CE</sub> = 70 V <sub>dc</sub> , V <sub>EB(off)</sub> = 1.5 V <sub>dc</sub> ) (V <sub>CE</sub> = 70 V <sub>dc</sub> , V <sub>EB(off)</sub> = 1.5 V <sub>dc</sub> , T <sub>C</sub> = 150°C)	I <sub>CEX</sub>	–	0.02 2	mA <sub>dc</sub>
Collector Cutoff Current (V <sub>CB</sub> = 70 V <sub>dc</sub> , I <sub>E</sub> = 0) (V <sub>CB</sub> = 70 V <sub>dc</sub> , I <sub>E</sub> = 0, T <sub>C</sub> = 150°C)	I <sub>CBO</sub>	–	0.02 2	mA <sub>dc</sub>
Emitter Cutoff Current (V <sub>BE</sub> = 5 V <sub>dc</sub> , I <sub>C</sub> = 0)	I <sub>EBO</sub>	–	0.5	mA <sub>dc</sub>
<b>ON CHARACTERISTICS</b>				
DC Current Gain (Note 2) (I <sub>C</sub> = 4 A <sub>dc</sub> , V <sub>CE</sub> = 4 V <sub>dc</sub> ) (I <sub>C</sub> = 10 A <sub>dc</sub> , V <sub>CE</sub> = 4 V <sub>dc</sub> )	h <sub>FE</sub>	20 5	100 –	–
Collector–Emitter Saturation Voltage (Note 2) (I <sub>C</sub> = 4 A <sub>dc</sub> , I <sub>B</sub> = 0.4 A <sub>dc</sub> ) (I <sub>C</sub> = 10 A <sub>dc</sub> , I <sub>B</sub> = 3.3 A <sub>dc</sub> )	V <sub>CE(sat)</sub>	–	1.1 8	V <sub>dc</sub>
Base–Emitter On Voltage (Note 2) (I <sub>C</sub> = 4 A <sub>dc</sub> , V <sub>CE</sub> = 4 V <sub>dc</sub> )	V <sub>BE(on)</sub>	–	1.8	V <sub>dc</sub>
<b>DYNAMIC CHARACTERISTICS</b>				
Current–Gain – Bandwidth Product (I <sub>C</sub> = 500 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> , f = 500 kHz)	f <sub>T</sub>	2	–	MHz

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

### ORDERING INFORMATION

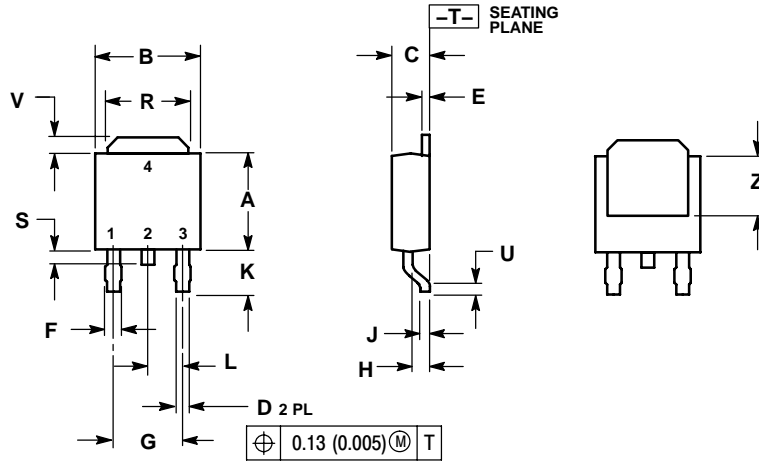
Device	Package Type	Package	Shipping†
MJD2955	DPAK	369C	75 Units / Rail
MJD2955G	DPAK (Pb–Free)		
MJD2955–001	DPAK–3	369D	
MJD2955–001G	DPAK (Pb–Free)		
MJD2955T4	DPAK	369C	2500 Tape & Reel
MJD2955T4G	DPAK (Pb–Free)		
MJD3055	DPAK		75 Units / Rail
MJD3055G	DPAK (Pb–Free)		
MJD3055T4	DPAK		2500 Tape & Reel
MJD3055T4G	DPAK (Pb–Free)		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MJD2955 (PNP) MJD3055 (NPN)

## PACKAGE DIMENSIONS

**DPAK**  
CASE 369C-01  
ISSUE O

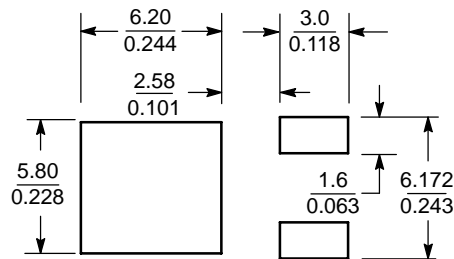


- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.245	5.97	6.22
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020	---	0.51	---
V	0.035	0.050	0.89	1.27
Z	0.155	---	3.93	---

- STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

### SOLDERING FOOTPRINT\*



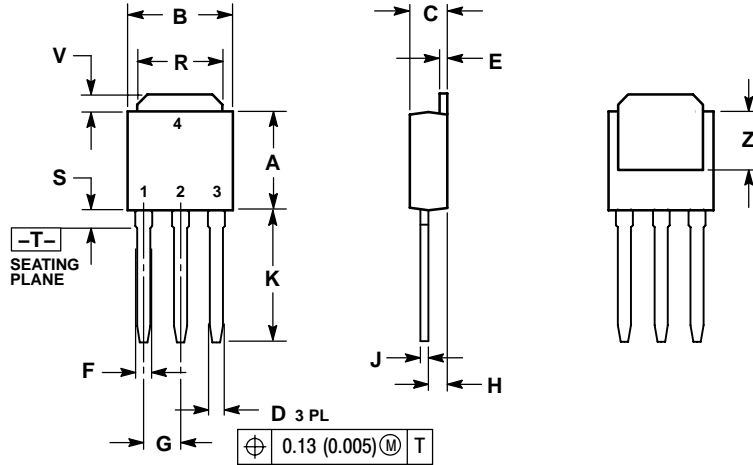
SCALE 3:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MJD2955 (PNP) MJD3055 (NPN)

## PACKAGE DIMENSIONS

DPAK-3  
CASE 369D-01  
ISSUE B



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.245	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.090 BSC		2.29 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.180	0.215	4.45	5.45
S	0.025	0.040	0.63	1.01
V	0.035	0.050	0.89	1.27
Z	0.155	---	3.93	---

- STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR